

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage		V _{GSS}	±20	V	
Continuous Drain Current (Note 6)	V _{GS} = -10V	T _A = +25°C T _A = +70°C	ID	300 250	mA
Pulsed Drain Current (Note 6)			I _{DM}	-1	А

Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units	
Tatal Dowar Dissinction	(Note 5)	D	370	mW	
Total Power Dissipation	(Note 6)	PD	540		
Thermal Resistance, Junction to Ambient	(Note 5)		348		
mermar Resistance, sunction to Ambient	(Note 6)	R _{0JA}	241	°C/W	
Thermal Resistance, Junction to Case	(Note 6)	R _{θJC}	91		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

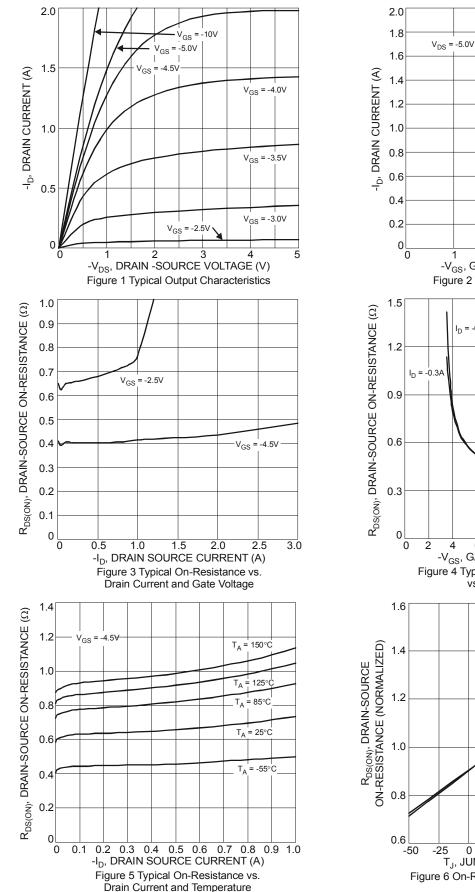
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

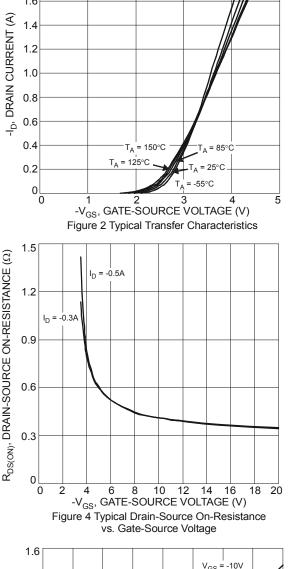
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	V_{GS} = 0V, I_D = -1mA	
Zero Gate Voltage Drain Current TJ = +25°C	IDSS	—	_	-1	μA	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	—	_	±10	μA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	-						
Gate Threshold Voltage	V _{GS(th)}	-1.4 -1.2	—	-2.4 -2.0	V	V _{DS} = V _{GS} , I _D = -250μA V _{DS} = -5V, I _D = -1μA	
Static Drain-Source On-Resistance		_	_	2.4	Ω	V _{GS} = -10V, I _D = -0.3A	
Static Drain-Source On-Resistance	R _{DS (ON)}			4		V _{GS} = -4.5V, I _D = -0.25A	
Forward Transfer Admittance	Y _{fs}	—	6	_	S	V _{DS} = -10V, I _D = -400mA	
Diode Forward Voltage	V _{SD}	—	0.8	1.2	V	V _{GS} = 0V, I _S = -300mA	
DYNAMIC CHARACTERISTICS (Note 8)	-						
Input Capacitance	Ciss	_	51.16	—	pF	V _{DS} = -15V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss		10.85	—	pF		
Reverse Transfer Capacitance	Crss	_	8.88		pF		
Gate Resistance	Rg	—	275	_	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz	
Total Gate Charge	Qg	_	0.6	_	nC	V _{GS} = -4.5V	
Total Gate Charge	Qg	—	1.2	_	nC	V _{DS} = -10V,	
Gate-Source Charge	Q _{qs}		0.2	—	nC	V _{GS} = -10V I _D = -1A	
Gate-Drain Charge	Q _{qd}	_	0.3	—	nC		
Turn-On Delay Time	t _{D(on)}	_	9.86	—	ns	V _{DS} = -15V, I _D = -1A V _{GS} = -10V, R _G = 6Ω	
Turn-On Rise Time	tr	_	11.5		ns		
Turn-Off Delay Time	t _{D(off)}	_	31.8		ns		
Turn-Off Fall Time	t _f		21.9	—	ns		

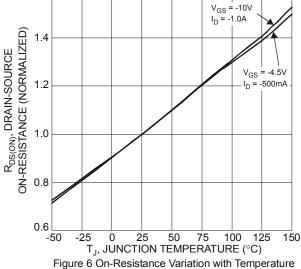
Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.





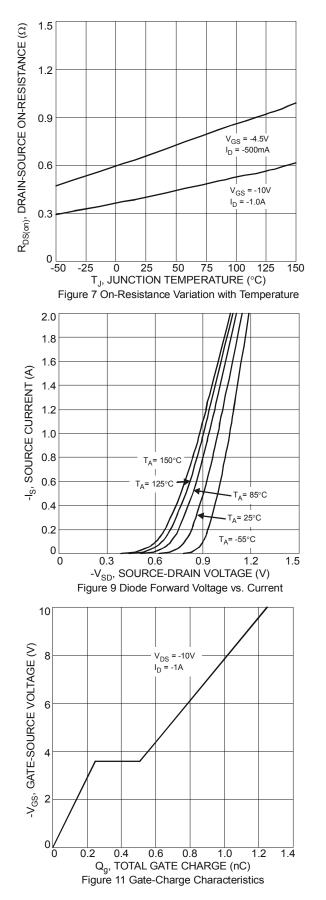


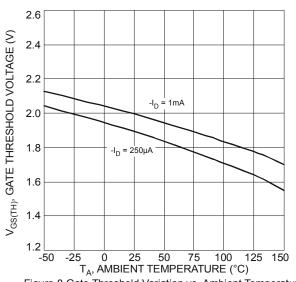


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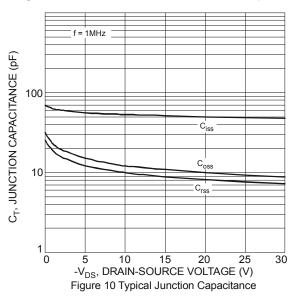








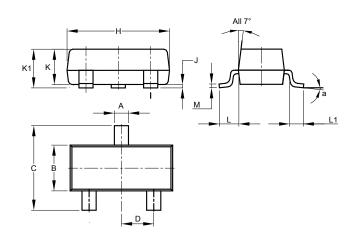






Package Outline Dimensions

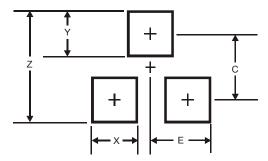
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
в	1.20	1.40	1.30		
C	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
κ	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	8°				
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
Z	2.9			
Х	0.8			
Y	0.9			
С	2.0			
E	1.35			



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